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WORDLINE-BASED SOURCE-BIASING SCHEME FOR REDUCING MEMORY CELL LEAKAGE

BACKGROUND OF THE INVENTION

Technical Field of the Invention

[0001] The present invention relates generally to semiconductor memories. More particularly, and not by way of any limitation, the present invention is directed to a wordline-based source-biasing scheme for reducing leakage in Static Random Access Memory (SRAM) cells.

Description of Related Art

[0002] Static Random Access Memory or SRAM devices comprising a plurality of memory cells are typically configured as an array of rows and columns, with one or more I/Os (i.e., x4, x8, x16, etc. configurations). Also, such memories may be provided in a multi-bank architecture for applications where high density, high speed and low power are required. Regardless of the architecture and type, each SRAM cell is operable to store a single bit of information. Access to this information is facilitated by activating all memory cells

a given row (by driving a wordline associated therewith) and outputting the data onto bitlines associated with a selected column for providing the stored data value to the selected output. Once the data is disposed on the bitlines, voltage levels on the bitlines begin to separate to opposite power supply rails (e.g., $\ensuremath{V_{DD}}$ and ground), and a sense amp is utilized to latch the logic levels sensed on the bitlines after they are separated by a predetermined voltage difference, typically 10% or less of V_{DD} . Furthermore, the sense amp may be provided as a differential sense amp, with each of the memory cells driving both a data signal and a databar signal on the complementary bitlines (i.e., data lines) associated with each column. In operation, prior activating the memory cells, the bitlines are precharged and equalized to a common value. Once a particular row and column are selected, the memory cell corresponding thereto is activated such that it pulls one of the data lines toward ground, with the other data line remaining at the precharged level, typically Vpn. sense amp coupled to the two complementary bitlines senses the difference between the two bitlines once it exceeds a predetermined value and the sensed difference is indicated to the sense amp as the differing logic states of "0" and "1".

[0003] As the transistor device sizes continue to decrease, e.g., 0.13μ or smaller, several issues begin to emerge with respect to the operation of SRAM cells,

chiefly because at such dimensions the devices suffer from high values of leakage in the off state in standby mode. Essentially, these devices are no longer ideal switches; rather they are closer to sieves, having a nonnegligible constant current flow path from drain to source or from drain/source to substrate even in the off The high leakage causes two major problems. First, because of the generation of large static current as leakage, there is increased static power consumption as a result. Second, which is more serious, is the issue incorrect data reads from the SRAM cells. accumulated leakage current from all the bitcells in a selected column is now comparable to the read current, thereby significantly eroding the bitline differential required for reliable sensing operations.

[0004] A technique for reducing standby leakage currents in a SRAM cell is disclosed in a recent article titled "16.7fA/cell Tunnel-Leakage-Suppressed 16Mb SRAM for Handling Cosmic-Ray-Induced Multi-Errors" by Kenichi Osada, Yoshikazu Saitoh, Eishi Ibe and Koichiro Ishibashi (in IEEE International Solid-State Circuits Conference, 2003, pages 302-303), where the source terminals of a plurality of SRAM cells on a single bitline column are coupled together for providing a biasing potential. Whereas such a scheme is seen to reduce total standby current, it does not improve the ratio of read current (I_R) to cell leakage current (I_L), however.

SUMMARY OF THE INVENTION

[0005]

source-biasing scheme for SRAM in order to reduce leakage. In standby mode, wordlines are deselected and a source-biasing potential is provided to SRAM cells. read mode, a selected wordline deactivates the sourcebiasing potential provided to the selected row of SRAM cells, whereas the remaining SRAM cells on the selected bitline column continue to be source-biased. biasing potential may be provided by applying a select voltage to the source terminal of an SRAM cell or by appropriately biasing the body well potential thereof. The main idea of the source-biasing scheme is [0006] to reduce the leakage across the access devices (or, pass gates) of a bitcell (i.e., memory cell). Since the leakage across the pass gate is due to V_{ps} (= supply voltage), the present invention is directed to reducing it by raising the potential of ground node within the bitcell. Thus, in one implementation, the ground nodes (i.e., source terminals of the pull-down devices) of all bitcells in a row are connected together and maintained at around 100 to 300 millivolts, which can vary based on the cell technology, design rules, operating voltage, When a wordline is turned on, the ground potential for that row is switched to 0 by using a wordlineactivated multiplex switching mechanism. For bitcells with raised ground, on the other hand, the leakage is

The present invention provides a wordline-based

substantially reduced because of the biasing potential that continues to be maintained. Therefore, in one bitline column, only the bitcell being accessed will have leakage across the pass gate; all other cells will have significantly reduced leakage (due to their raised ground nodes) resulting in a read current that is significantly greater than any accumulated leakage.

[0007] In one aspect, the present invention is directed to an SRAM cell that is comprised of a pair of cross-coupled inverters forming a pair of data nodes. Each cross-coupled inverter includes a pull-up device and a pull-down device, wherein the pull-down device's source is biased by a select potential applied to a row of SRAM cells in which the SRAM cell is disposed. Also included in the SRAM cell are a pair of access devices, each being disposed between a respective data node and associated bitline, wherein gates of the access devices are operable to be driven by a wordline.

[0008] In another aspect, the present invention is directed to an SRAM instance that comprises a plurality of SRAM memory cells organized in an array having rows and columns. Each SRAM cell includes a pair of crosscoupled inverters that are coupled to form a pair of data nodes, wherein pull-down devices of the SRAM cells forming a row are coupled together to be biased by a bias potential in standby mode. A row decoder is provided for selectively activating wordlines based on a decoded

address, wherein each wordline is operable to drive a corresponding row of the array. In addition, a multiplexer is disposed between the row decoder and the array for deactivating the bias potential provided to the SRAM cells of a particular row when that row is driven by a wordline associated therewith.

[0009] In a still further aspect, the present invention is directed to a memory compiler for compiling at least one SRAM memory instance. The memory compiler includes a code portion for generating a plurality of SRAM memory cells organized in an array having rows and Each SRAM cell includes a pair of cross-coupled inverters that are coupled to form a pair of data nodes, wherein pull-down devices of the SRAM cells forming a row are coupled together to be biased by a bias potential in standby mode. A code portion is provided for generating a row decoder that is operable to selectively activate wordlines based on a decoded address, wherein each wordline is operable to drive a corresponding row of the array. In addition, another code portion is provided for generating a multiplexer that is disposed between the row decoder and the array for deactivating the bias potential provided to the SRAM cells of a particular row when that row is driven by a wordline associated therewith.

BRIEF DESCRIPTION OF THE DRAWINGS

- [0010] A more complete understanding of the present invention may be had by reference to the following Detailed Description when taken in conjunction with the accompanying drawings wherein:
- [0011] FIG. 1 depicts an exemplary embodiment of a source-biased SRAM cell in accordance with the teachings of the present invention;
- [0012] FIG. 2 depicts an exemplary memory array portion comprising source-biased SRAM cells according one embodiment of the present invention;
- [0013] FIG. 3 depicts an exemplary embodiment of an SRAM instance that includes a wordline multiplexer (MUX) circuit for use with the memory array shown in FIG. 2 for effectuating leakage reduction therein in accordance with the teachings of the present invention;
- [0014] FIG. 4 is a flow chart of memory operations according to one embodiment of the present invention;
- [0015] FIG. 5 depicts a set of waveforms relating to memory operations in accordance with one embodiment of the present invention; and
- [0016] FIGS. 6A-6C depict a plurality of graphs for illustrating the restorative effect of wordline-based source biasing on the read current in accordance with the teachings of the present invention.

DETAILED DESCRIPTION OF THE DRAWINGS

[0017] In the drawings, like or similar elements are designated with identical reference numerals throughout the several views thereof, and the various elements depicted are not necessarily drawn to scale. Referring to FIG. 1, depicted therein is an exemplary embodiment of a source-biased SRAM cell 100 in accordance with the teachings of the present invention where leakage advantageously reduced without disturbing integrity of stored data. As illustrated, SRAM cell 100 is provided with a pair of complementary bitlines, BT 114A and BB 114B where each of the complementary bitlines may be coupled to appropriate precharge circuitry (not shown in this FIG.) such that it is pulled to a power supply rail or a reference voltage source (typically V_{pp} or any portion thereof) when the precharge circuitry is activated.

[0018] The memory cell, also referred to as bitcell, 100 is comprised of a 4T-CMOS latch 102 that includes a pair of cross-coupled inverters to form a pair of data nodes 108A and 108B. A first P-channel field effect transistor (P-FET) 106A operating as a pull-up device of one of the inverters has its source/drain terminals connected between V_{DD} and a first data node 108A, with the gate thereof connected to a second data node 108B. As is well known, the data nodes 108A and 108B operate as the two complementary storage nodes in the memory cell 100.

An N-channel FET (N-FET) 104A operating as a pull-down device has its drain connected to the data node 108A and its source connected to a wordline-based source bias control line (SL) 116 that is switchably connected to a bias potential as will be described in greater detail hereinbelow. The gate of N-FET 104A is coupled to the second data node 108B. With respect to the other inverter, a second P-FET 106B is operable as a pull-up device having its source/drain terminals connected between V_{DD} and the data node 108B, with the gate thereof connected to the data node 108A. A second N-FET 104B is operable as a pull-down device wherein the drain is coupled to the data node 108B and the source is commonly connected to the source bias control line 116.

[0019] A first N-FET access device 112A is disposed between BT 114A and the data node 108A, with the gate thereof coupled to a wordline (WL) 110. In similar fashion, a second N-FET access device 112B has the source/drain thereof connected between BB 114B and the data node 108B, wherein its gate is also driven by WL 110. The cross-coupled inverters of the memory cell form latch 102, where nodes 108A and 108B are operable to hold logic levels that correspond to stored data.

[0020] Initially, in one embodiment of a memory standby mode, WL 110 is held low and the precharge circuitry associated with the bitlines is activated so as to pull the bitlines to a predetermined high voltage.

Further, SL 116 is raised to a select potential (having a range approximately from around 100 millivolts to 300 millivolts, the value being determined such that the logic levels that correspond to stored data at nodes 108A and 108B are not disturbed, which depends on the SRAM cell technology, operating voltage levels, device sizing, et cetera). Because of the biasing of the sources of the N-FET pull-down devices 104A and 104B by SL 116, the leakage current through access devices 112A and 112B is significantly reduced. Since leakage in each bitcell on a select bitline column is accordingly reduced, the cumulative leakage current in a select bitline is also reduced such that the read current margin that developed on that bitline when any WL is driven high to select a bitcell thereon is not eroded. That is, by way of example, the precharge circuitry (not shown) is turned off during a read operation and WL 110 is activated (based on address decoding) so as to turn on the access transistors 112A and 112B. Accordingly, the data node 108A is coupled to BT 114A and the data node 108B is coupled to BB 114B. If, for example, a logic "0" was stored on the data node 108A and a logic "1" was stored on the data node 108B, N-FET 104A would be turned on and N-FET 104B would be turned off. As will be described in additional detail below, a multiplexing mechanism is provided for deactivating the source biasing potential applied via SL 116 to the N-FET devices of a selected bitcell during a read operation. Thus, N-FET 104A would

pull BT 114A low, whereas BB 114B would swing to a voltage level based on the logic "1" of the data node 108B, thereby developing the bitline differential operable to drive appropriate sense amp circuitry for reading data.

FIG. 2 depicts an exemplary SRAM array portion [0021] source-biased memory comprising cells (SBMCs) according one embodiment of the present invention. illustrated, 16 bitcells, SBMC(0,0) to SBMC(3,3), disposed in a 4-by-4 array, where bitcells of each row are provided with a commonly coupled SL control line along with the associated WL corresponding to the row. In FIG. 2, SLO to SL3 exemplify four commonly coupled source bias control signal lines, each operating with respect to a particular row of bitcells. As a further variation, it should be apparent that a biasing potential may also be provided by appropriately biasing the body well potential of the SBMCs, e.g., by controlling the VBS potential between an N-FET pull-down device's source and its p-well body.

[0022] Referring now to FIG. 3, depicted therein is an exemplary embodiment of an SRAM instance 300 that includes a wordline multiplexer (MUX) circuit 302 for use with the memory array portion 200 shown in FIG. 2 for effectuating leakage reduction therein in accordance with the teachings of the present invention. Row decoder (XDEC) 303 including XDEC portions 304-0 to 304-3 is

operable responsive to row address signals provided by a control block (not shown in this FIG.) so as to activate a select WL, i.e., WLO through WL3. The MUX circuit 302 disposed between XDEC 303 and memory array 200 is operable to deactivate a source bias potential (V_{REF} that is normally coupled to SLO-SL3 in standby) provided to a particular row of bitcells when that row is driven (i.e., selected) by a wordline associated therewith.

In the illustrated embodiment, MUX 302 comprised of a plurality of bias switch elements 306-0 to 306-3, each corresponding to a particular WL. Each bias switch element includes logic circuitry driven by the corresponding WL to deactivate V_{REF} from the associated SL when WL is driven high. This WL-based switching logic is particularly exemplified in the following with respect to bias switch element 306-2. In standby mode, WL2 is low (i.e., deselected) which turns off a pass gate 310, thereby decoupling SL2 from ground. Also, operable to drive an inverter 308 to output a logic high which consequently turns on another pass gate 312, thereby coupling SL2 to V_{REF} . When WL2 is selected (i.e., driven high) in a read operation, the logic of the switch element 306-2 operates to turn on pass gate 310, thereby coupling SL2 to ground and to turn off pass gate 312, thereby decoupling SL2 from V_{REF}. Accordingly, only the row of bitcells associated with WL2 and SL2, i.e., SBMC(2,0), SBMC(2,1), SBMC(2,2), SBMC(2,3), have their

source-biasing turned off during a read operation associated therewith.

[0024] FIG. 4 is a flow chart of memory operations according to one embodiment of the present invention. As pointed out above, when the bitcells are in standby mode, the wordlines are in deselected state and SL control lines are driven to a select potential (block 402). When a memory read address is activated pursuant to a read operation, a selected WL (based on the decoded address) is driven high (block 404). Subsequently, MUX logic circuitry described above operates such that associated with row-selected bitcell is driven low, whereas SL control lines of the remaining bitcells on the selected bitline column (based on a column address) are maintained at the select potential (block 406). sensing the read voltage differential developed on the selected bitline column as part of the read operation, the memory cells may revert to standby mode (block 408). [0025] FIG. 5 depicts a set of waveforms relating to memory operations in accordance with one embodiment of the present invention. Reference numeral 502 refers to the voltage level on a WL (V_{WL}) and reference numeral 504 refers to the inverted V_{WL} . As depicted, when there is a rising edge on V_{WL} , the inverted V_{WL} is driven low to generate a falling edge therein. As a result, the source bias 506 is also driven low, whereupon normal read current is developed for sensing.

[0026] FIGS. 6A-6C depict a plurality of graphs for illustrating the restorative effect of wordline-based source biasing on the read current in accordance with the teachings of the present invention. In particular, FIGS. 6A and 6B illustrate the prior art conditions where there is either little or no leakage at all (due to legacy technology), or where there is a substantial leakage (due to shrinking geometries) that causes reduced bitline differentials. FIG. 6C illustrates the condition where the present invention advantageously restores the bitline differentials by substantially reducing the leakage current effect. By way of an example, consider where SRAM cell read current (I_R) is about 24 μA . current per unselected cell (I_{LC}) is deemed to be about 0.006 µA where the present invention's source-biasing technique is implemented. If there are 1000 cells per bitline, total contribution of all unselected cells (I_{LT}) would be about 6 μ A (= 0.006 μ A x 1000). The effective signal is therefore reduced by 25% (since I_{LT}/I_R = 6/24 = 1/4). If SL is biased at around 300 mV according to the wordline-based source biasing scheme of the present invention, I_{LC} is reduced to 0.000180 μA . Therefore, for 1000 cells/BL, I_{LT} = 0.180 μ A. Accordingly, there is less than 1% loss in the read current signal, thereby significantly improving memory access operations.

[0027] Based on the foregoing, it should be appreciated that the present invention provides a simple

yet efficient and elegant leakage reduction scheme whereby cell read currents are not compromised as the memory cell technology evolves beyond the current designs Additionally, the wordline-based source of 0.13u. biasing mechanism as disclosed herein is adaptable to different SRAM sizes, configurations, and device sizes, wherein source-bias potential levels may be appropriately selected so as not to have deleterious effects (e.g., with respect to the integrity of stored data). skilled in the art should also readily recognize upon reference hereto that source-biasing potential may be provided by applying a select voltage to the source terminal of an SRAM cell or by appropriately biasing the body well potential thereof. Furthermore, it should be apparent that the teachings of the present invention may be practiced in standalone SRAM devices as well as compilable SRAM applications having one or more SRAM instances.

[0028] It. is believed that the operation construction of the present invention will be apparent from the foregoing Detailed Description. While some aspects of the method and circuitry shown and described may have been characterized as being preferred, it should readily understood that various changes modifications could be made therein without departing from the scope of the present invention as set forth in the following claims.